	CM Sar hnology Corp			
SPECIFICA1	TION FOR A	PPROVAL		
CUSTOMER				
NOMINAL FREQUENCY	16.00	16.000000 MHz		
PRODUCT TYPE	TYPE FL 3.2x2.5 S	EAM SEALED CRYSTAL		
SPEC. NO. ( P/N )	FL	1600044		
CUSTOMER P/N				
ISSUE DATE	SUE DATE Decer			
VERSION	DN B			
APPROVED	PREPARED	QA		
Alan Yang	Brenda	Canthen		
APPROVED BY	APPROVED BY CUSTOMER :			
Please return one copy w	<i>v</i> ith approval to PSE-TW			
PSE Technology Corpo				
No.2, Tzu-Chiang 5th Rd, Chung Li Industrial Park, Chung Li City, Taoyuan County, Taiwan (R.O.C.)*PtTEL: 886-3-451-8888 FAX: 886-3-461-3865 http://www.saronix-ecera.com.tw*Rf		Pb-free RoHS Compliant HF-Halogen Free REACH Compliant		
*** A company of 🧖	PERICOM Semicond	uctor Corporation ***		

# TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL

## FL1600044

VER. B 5-Dec-11

## **VERSION HISTORY**

Version No.	Version Date	Customer Receipt Date	Supplier Receipt Date	Description	Notes
А	Apr.29,2009			Initial Release	
В	Dec.5,2011			Updated Suggested IR Reflow Profile & Format	
			1		
			1		
			1		



# **TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL**

## FL1600044

VER. B 5-Dec-11

### **ELECTRICAL SPECIFICATIONS**

ltem	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	16.000000	MHz	
Mode of Oscillation	MO	AT Cut-Fundamental		
Calibration Load Capacitance	CL	8	pF	
Calibration Tolerance	FL	±15	ppm	at 25°C±3°C
Operating Temperature Range	TR	-10 to +75	°C	
Frequency Stability (Frequency Deviation over the Operating Temperature Range)	F/T	±15	ppm	Reference to the Frequency at 25°C
Operating Drive Level		10	μW	
Maximum Drive Level		200	μW	
Equivalent Series Resistance	ESR	80	Ω	Мах
Shunt Capacitance	C0	5	pF	Мах
Aging at 25°C		±3	ppm	Max, 1st year
Storage Temperature		-55 to +125	°C	
Insulation Resistance		500	MΩ	Min

\* This product doesn't include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).



## **TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL**

### FL1600044

VER. B 5-Dec-11

### **RELIABILITY SPECIFICATIONS**

#### **MECHANICAL AND ENVIRONMENTAL RATINGS:**

a) FINE LEAK TEST: JESD22-A109 (Condition 1A)

b) GROSS LEAK TEST: JESD22-A109 (Condition C)

c) MOISTURE RESISTANCE: JESD22-A113

d) SHOCK: JESD22-B104 (Condition B)

e) SOLDERABILITY : (RoHS version): J-STD-002

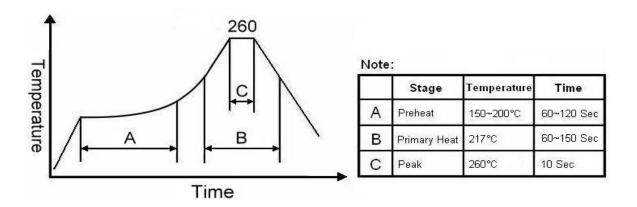
f) VIBRATION: JESD22-B103

g) SOLVENT RESISTANCE: JESD22-B107

h) RESISTANCE TO SOLDERING HEAT (RoHS version): J-STD-020D Table 5.2 Pb free devices (3 cycles max)

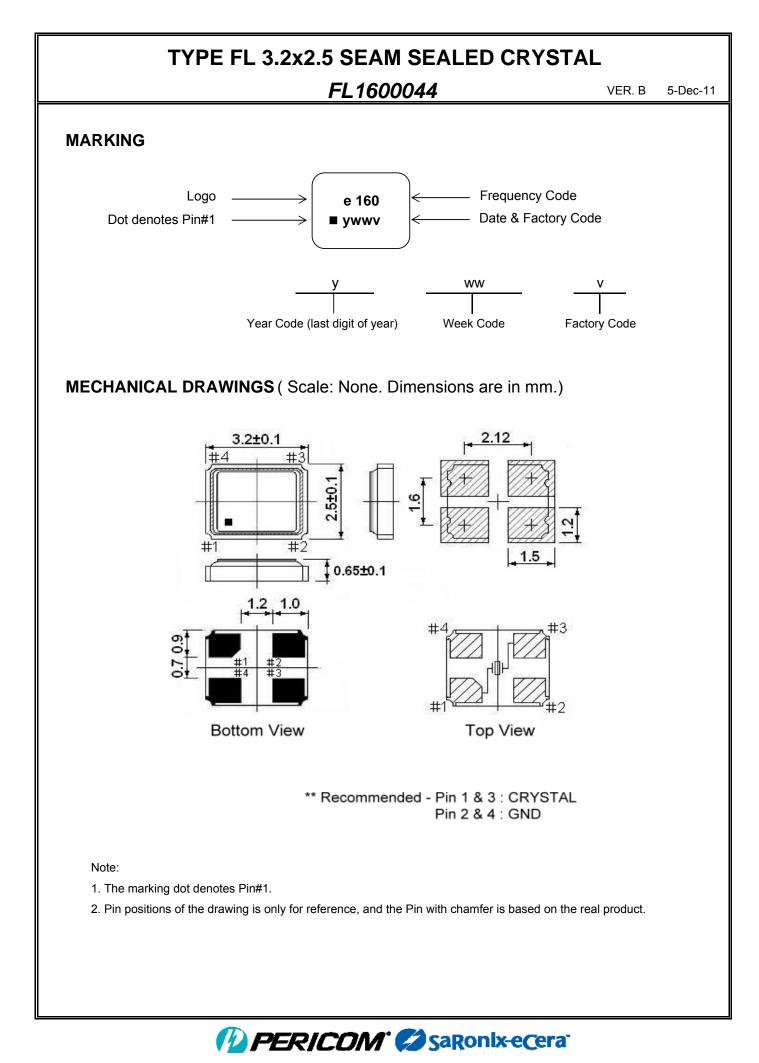
#### SUGGESTED IR REFLOW PROFILE

\*As per IPC-JEDEC J-STD-020D



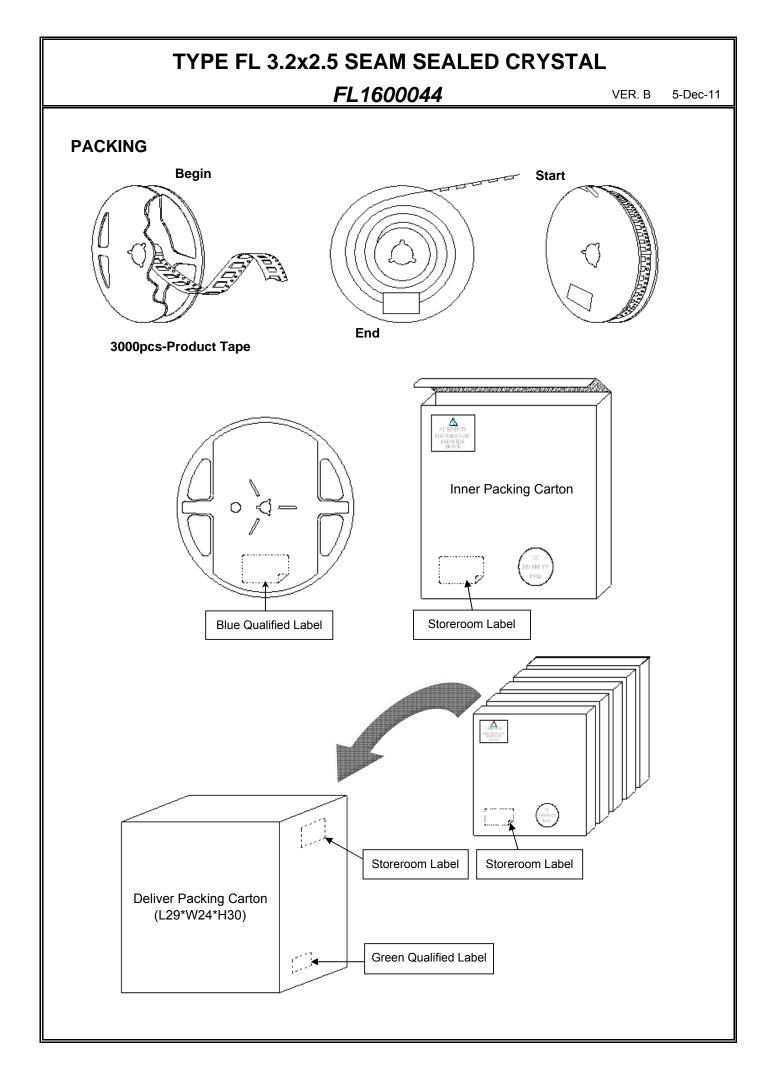
For soldering reflow profile and reliability test ratings go to: http://www.pericom.com/pdf/sre/reflow.pdf





# TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL FL1600044 VER. B 5-Dec-11 Tape & Reel Index Mark 2.0 Ø1.0 ,25±0,05 Ø1.55 4.01.75 R0.3 $\oplus$ (MAX.) Ŧ 3.5±0.05 8±0.2 3.4 53 2.7 8.0 Feeding 1.4 Ø60.2±0.5 178-3 9,0±0,3 12±1.4 1. 230mm minimum leafer which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape. 2. 160mm minimum trailer of empty carrier tape sealed with cover tape.







# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Diodes Incorporated: FL1600044